

Benefits

- Very low thermal resistance of $0.05^{\circ}\text{Cin}^2/\text{W}$ ($0.32^{\circ}\text{Ccm}^2/\text{W}$)
- High thermal conductivity of 2.2 W/m-K
- High temperature applications
- Lead-free solder compatible
- Eutectic AuSn compatible
- RoHS compliant and environmentally green
- Available on all aluminum and copper metal substrates

Thermal Clad Metal Core PCB's (MCPCB's) minimize thermal impedance and conduct heat more effectively than standard printed wiring boards (PWB's). These substrates are more mechanically robust than thick-film ceramic and direct bond copper construction.

Thermal Clad is a cost-effective solution which can eliminate components, allow for simplified designs, smaller devices and an overall less complicated production process. Additional benefits of Thermal Clad include lower operating temperatures, resulting in longer component life and increased durability.

The technology of Thermal Clad resides in the dielectric. This datasheet highlights the performance characteristics of Thermal Clad HT 3 mils (High Temperature) a dielectric resistant to degradation from high temperature exposure and features high dielectric breakdown characteristics. This dielectric is proven in applications such as LED, Power Conversion, Heat-Rails, Solid State Relays and Motor Drives.

HT Dielectric Typical Values

HT-04503	VALUE	TEST METHOD
----------	-------	-------------

THERMAL PROPERTIES

Thermal Conductivity	2.2 W/m-K	ASTM D5470
Thermal Resistance	0.05°C-in ² /W (0.32°C-cm ² /W)	ASTM D5470
Thermal Impedance	0.45°C/W	MET-5.4-01-40000
Glass Transition	150°C	ASTM E1356
Max Operating Temp.	140°C	U.L. 796
Max Soldering Temp.	325°C	U.L. 796

ELECTRICAL PROPERTIES

Dielectric Constant	7	ASTM D150
Dissipation Factor	.0033/0.148 (@1KHz/1MHz)	ASTM D150
Capacitance	540 pF/in ² (85pF/cm ²)	ASTM D150
Volume Resistivity	1 ¹⁴ Ω-m	ASTM D257
Surface Resistivity	1 ¹³ Ω/sq	ASTM D257
Dielectric Strength	2000 V/mil (80 kV/mm)	ASTM D149
Breakdown Voltage	8.5 kVAC	ASTM D149

MECHANICAL PROPERTIES

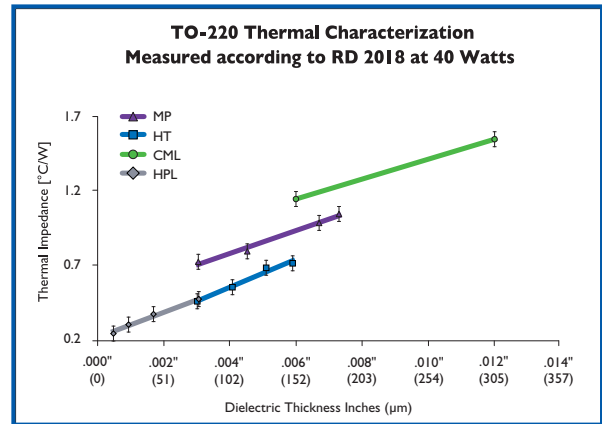
Color	White	Visual
Dielectric Thickness	0.003" (76 μm)	Visual
Peel Strength@25C	6 lb/in (1.1 N/mm)	ASTM D2861
CTE in XY/Z Axis <T _g	25 μm/m°C	ASTM D3386
CTE in XY/Z Axis >T _g	95 μm/m°C	ASTM D3386
Storage Modulus	16/73 GPa (@25°C/150°C)	ASTM 4065

CHEMICAL PROPERTIES

Water Vapor Retention	0.24% wt.	ASTM E595
Out-Gassing Total Mass Loss	0.28% wt.	ASTM E595
Collect Volatile Condensable Material	0.01% wt.	ASTM E595

AGENCY RATINGS & DURABILITY

U.L. Continuous Operating Temperature	140°C	U.L. 746B
U.L. Flammability	V-0	U.L. 94
Comparative Tracking Index (CTI)	0	ASTM D3638
Solder Float	Pass	IPC TM 650 2.4.13



Applications

- High watt-density applications where achieving low thermal resistance is required
- Power conversion
- Heat-rails
- Solid state relays
- Motor drives
- LED applications
- Solar receivers

Please test this material in your application. Bergquist provides this engineering data for design guidance only. Depending upon your application, the observed material performance may vary.



www.bergquistcompany.com

The Bergquist Company -
North American Headquarters
Phone: 800-347-4572
Fax: 952-835-4156

The Bergquist Company -
European Headquarters
Phone: 31-35-5380684
Fax: 31-35-5380295

The Bergquist Company -
Asian Headquarters
Phone: 852-2690-9296
Fax: 852-2690-2344

All statements, technical information and recommendations herein are based on tests we believe to be reliable, and THE FOLLOWING IS MADE IN LIEU OF ALL WARRANTIES, EXPRESSED OR IMPLIED, INCLUDING THE IMPLIED WARRANTIES OF MARKETABILITY AND FITNESS FOR PURPOSE. Sellers' and manufacturers' only obligation shall be to replace such quantity of the product proved to be defective. Before using, user shall determine the suitability of the product for its intended use, and the user assumes all risks and liability whatsoever in connection therewith. NEITHER SELLER NOR MANUFACTURER SHALL BE LIABLE EITHER IN TORT OR IN CONTRACT FOR ANY LOSS OR DAMAGE, DIRECT, INCIDENTAL OR CONSEQUENTIAL, INCLUDING LOSS OF PROFITS OR REVENUE ARISING OUT OF THE USE OR THE INABILITY TO USE A PRODUCT. No statement, purchase order or recommendations by seller or purchaser not contained herein shall have any force or effect unless in an agreement signed by the officers of the seller and manufacturer.

PDS_HT_1_0211